

## PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
LM285D-1-2	OBSOLETE	SOIC	D	8		TBD	Call TI	Call TI	-40 to 85	285-12	
LM285DG4-1-2	NRND	SOIC	D	8	75	TBD	Call TI	Call TI	-40 to 85		
LM285DR-1-2	OBSOLETE	SOIC	D	8		TBD	Call TI	Call TI	-40 to 85	285-12	
LM285DRE4-1-2	NRND	SOIC	D	8	2500	TBD	Call TI	Call TI	-40 to 85		
LM285DRG4-1-2	NRND	SOIC	D	8	2500	TBD	Call TI	Call TI	-40 to 85		
LM285LP-1-2	ACTIVE	TO-92	LP	3	1000	RoHS & Green	SN	N / A for Pkg Type	-40 to 85	285-12	Samples
LM285LPE3-1-2	ACTIVE	TO-92	LP	3	1000	RoHS & Green	SN	N / A for Pkg Type	-40 to 85	285-12	Samples
LM285LPRE3-1-2	ACTIVE	TO-92	LP	3	2000	RoHS & Green	SN	N / A for Pkg Type	-40 to 85	285-12	Samples
LM385BD-1-2	OBSOLETE	SOIC	D	8		TBD	Call TI	Call TI	0 to 70	385B12	
LM385BDG4-1-2	NRND	SOIC	D	8	75	TBD	Call TI	Call TI	0 to 70		
LM385BDR-1-2	OBSOLETE	SOIC	D	8		TBD	Call TI	Call TI	0 to 70	385B12	
LM385BLP-1-2	ACTIVE	TO-92	LP	3	1000	RoHS & Green	SN	N / A for Pkg Type	0 to 70	385B12	Samples
LM385BLPE3-1-2	ACTIVE	TO-92	LP	3	1000	RoHS & Green	SN	N / A for Pkg Type	0 to 70	385B12	Samples
LM385BLPR-1-2	ACTIVE	TO-92	LP	3	2000	RoHS & Green	SN	N / A for Pkg Type	0 to 70	385B12	Samples
LM385BLPRE3-1-2	ACTIVE	TO-92	LP	3	2000	RoHS & Green	SN	N / A for Pkg Type	0 to 70	385B12	Samples
LM385BPW-1-2	OBSOLETE	TSSOP	PW	8		TBD	Call TI	Call TI	0 to 70	385B12	
LM385BPWR-1-2	ACTIVE	TSSOP	PW	8	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	385B12	Samples
LM385D-1-2	OBSOLETE	SOIC	D	8		TBD	Call TI	Call TI	0 to 70	385-12	
LM385DG4-1-2	NRND	SOIC	D	8	75	TBD	Call TI	Call TI	0 to 70		
LM385DR-1-2	OBSOLETE	SOIC	D	8		TBD	Call TI	Call TI	0 to 70	385-12	
LM385LP-1-2	ACTIVE	TO-92	LP	3	1000	RoHS & Green	SN	N / A for Pkg Type	0 to 70	385-12	Samples
LM385LPR-1-2	ACTIVE	TO-92	LP	3	2000	RoHS & Green	SN	N / A for Pkg Type	0 to 70	385-12	Samples
LM385LPRE3-1-2	ACTIVE	TO-92	LP	3	2000	RoHS & Green	SN	N / A for Pkg Type	0 to 70	385-12	Samples
LM385PWR-1-2	ACTIVE	TSSOP	PW	8	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	385-12	Samples



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							(6)				
LM385PWRE4-1-2	NRND	TSSOP	PW	8	2000	TBD	Call TI	Call TI	0 to 70		

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(<sup>5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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